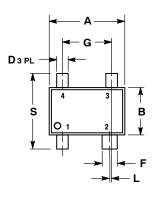
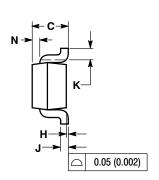




SC-82AB CASE 419C-02 ISSUE F

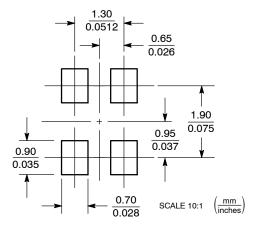
DATE 22 JUN 2012







SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETER.

 3. 419C-01 OBSOLETE. NEW STANDARD IS 419C-02.

 4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE RI IRRS.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.80	2.20	0.071	0.087
В	1.15	1.35	0.045	0.053
С	0.80	1.10	0.031	0.043
D	0.20	0.40	0.008	0.016
F	0.30	0.50	0.012	0.020
G	1.10	1.50	0.043	0.059
Н	0.00	0.10	0.000	0.004
J	0.10	0.26	0.004	0.010
K	0.10		0.004	
L	0.05 BSC		0.002 BSC	
N	0.20 REF		0.008 REF	
S	1.80	2.40	0.07 0.09	

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Month Code Μ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	SC-82AB		PAGE 1 OF 1	

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